Audio Streaming Reference Design Block Diagram

- **Power Management**: TPS650250
- **Sitara Cortex-A8**: AM3352
- **NAND**: 128mb
- **DDR3**: 256mb
- **USB Connector**: Vbus, D+, D-, I2C
- **WiLink8 Module**: WL1837
- **Audio Codec**: AIC3206
- **Apple Auth IC**
- **MMC/SD Card**
- **Line Out**
- **Headphone Out**

**Power Input**:
- DC-5V
- Battery (optional)
- USB DC-5V

**Power Output**:
- VDD_MPU
- VDD_CORE
- VDDS_DDR

**Interfaces**:
- SDIO
- UART
- I2C
- McASP

**Other Components**:
- Audio Streaming Reference Design Block Diagram

= TI Part Number

= Not available from TI

= Interface
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